

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Martin et al.

Serial No.:

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Title: PACKAGE FOR SEALING AN INTEGRATED CIRCUIT DIE

Examiner: Nathan Ha

Art Unit: 2814

Mail Stop Patent Application
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Prior to examination and prior to calculating the filing fee, please amend the application as follows:

Amendments to the Specification begin on page 2 of this paper.

Remarks begin on page 3 of this paper.